MBR40L45CTG, NRVBB40L45CTT4G

Switch-mode Power Rectifier 45 V, 40 A

Features and Benefits

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capacity
- 175°C Operating Junction Temperature
- 40 A Total (20 A Per Diode Leg)
- Guard-Ring for Stress Protection
- NRVBB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

Mechanical Characteristics:

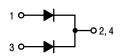
- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight (Approximately): 1.9 Grams (TO-220)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube for TO-220



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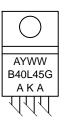
SCHOTTKY BARRIER RECTIFIERS 40 AMPERES, 45 VOLTS

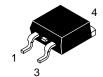


MARKING DIAGRAMS



TO-220 CASE 221A STYLE 6





D²PAK 3 CASE 418B STYLE 3



B40L45 = Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Device
AKA = Polarity Designator

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|-----------------------------------|-----------------------|
| MBR40L45CTG | TO-220 (Pb-Free) | 50 Units/Rail |
| NRVBB40L45CTT4G | D ² PAK 3 (Pb-Free) | 800 /Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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MAXIMUM RATINGS (Per Diode Leg)

| Rating | Symbol | Value | Unit |
|--|--|-----------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 45 | V |
| Average Rectified Forward Current (Rated V_R) $T_C = 145$ °C | I _{F(AV)} | 20 | А |
| Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz) | I _{FRM} | 40 | Α |
| Non-repetitive Peak Surge Current (Surge applied at rated load conditions half-wave, single phase, 60 Hz) | I _{FSM} | 200 | А |
| Operating Junction Temperature (Note 1) | TJ | -65 to +175 | °C |
| Storage Temperature | T _{stg} | -65 to +175 | °C |
| Voltage Rate of Change (Rated V _R) | dv/dt | 10,000 | V/μs |
| ESD Ratings: Machine Model = C Human Body Model = 3B | | > 400 > 8000 | V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|----------------------------|-----------------|-------|------|
| Maximum Thermal Resistance | | | °C/W |
| Junction-to-Case | $R_{	heta JC}$ | 1.9 | |
| Junction-to-Ambient | $R_{\theta JA}$ | 72.9 | |

ELECTRICAL CHARACTERISTICS (Per Diode Leg)

| Characteristic | Symbol | Value | Unit |
|--|----------------|------------------------------|------|
| Maximum Instantaneous Forward Voltage (Note 2) $ \begin{aligned} &(I_F=20~A,T_C=25^\circ\text{C})\\ &(I_F=20~A,T_C=125^\circ\text{C})\\ &(I_F=40~A,T_C=25^\circ\text{C})\\ &(I_F=40~A,T_C=125^\circ\text{C}) \end{aligned} $ | VF | 0.50 0.48 0.63 0.68 | V |
| Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$) (Rated DC Voltage, $T_C = 125^{\circ}C$) | i _R | 1.2 275 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%.

^{1.} The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

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TYPICAL CHARACTERISTICS

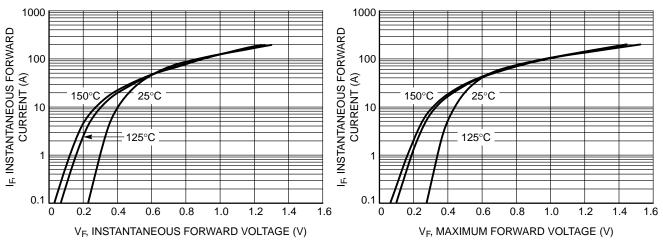


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

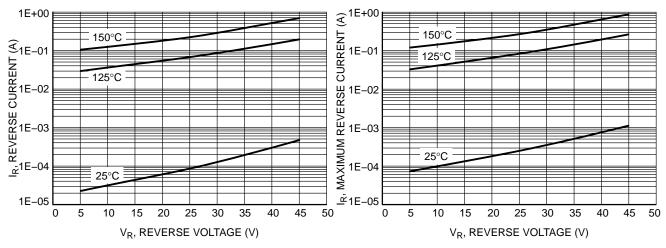


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

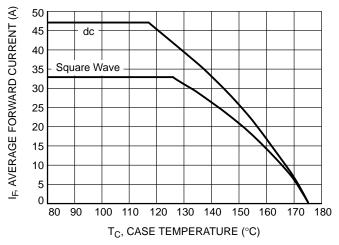


Figure 5. Current Derating for MBR40L45CTG

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TYPICAL CHARACTERISTICS

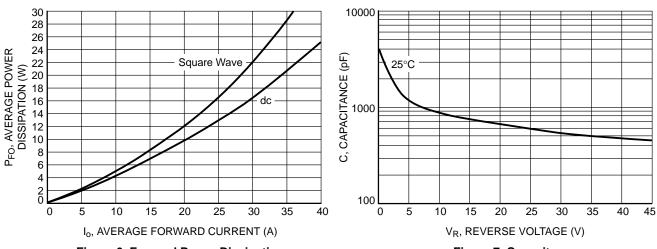


Figure 6. Forward Power Dissipation

Figure 7. Capacitance

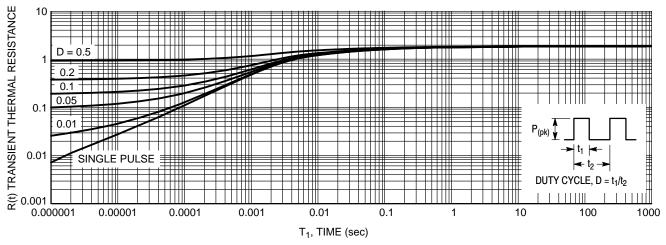


Figure 8. Thermal Response Junction-to-Case for MBR40L45CTG

MECHANICAL CASE OUTLINE

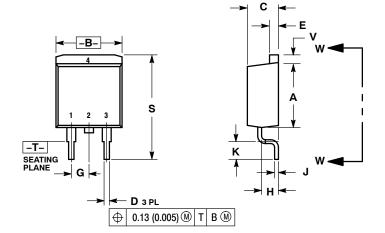




D²PAK 3 CASE 418B-04 **ISSUE L**

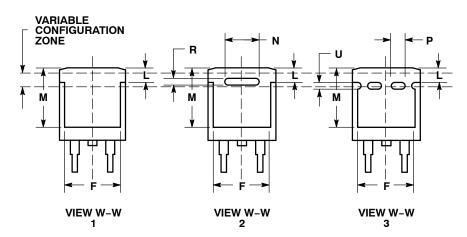
DATE 17 FEB 2015

SCALE 1:1



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
- 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

| | INCHES | | MILLIMETERS | |
|-----|---------------|-------|-------------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.340 | 0.380 | 8.64 | 9.65 |
| В | 0.380 | 0.405 | 9.65 | 10.29 |
| C | 0.160 | 0.190 | 4.06 | 4.83 |
| D | 0.020 | 0.035 | 0.51 | 0.89 |
| Е | 0.045 | 0.055 | 1.14 | 1.40 |
| F | F 0.310 0.350 | | 7.87 | 8.89 |
| G | 0.100 BSC | | 2.54 BSC | |
| Н | 0.080 | 0.110 | 2.03 | 2.79 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.090 | 0.110 | 2.29 | 2.79 |
| L | 0.052 | 0.072 | 1.32 | 1.83 |
| М | M 0.280 0.320 | | 7.11 | 8.13 |
| N | 0.197 REF | | 5.00 REF | |
| Р | 0.079 REF | | 2.00 REF | |
| R | 0.039 REF | | 0.99 REF | |
| S | 0.575 | 0.625 | 14.60 | 15.88 |
| ٧ | 0.045 | 0.055 | 1.14 | 1.40 |



STYLE 1: PIN 1. BASE 2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN STYLE 3:

PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

STYLE 4:

PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 5:

PIN 1. CATHODE 2. ANODE 3. CATHODE 4. ANODE

STYLE 6:

PIN 1. NO CONNECT
2. CATHODE
3. ANODE
4. CATHODE

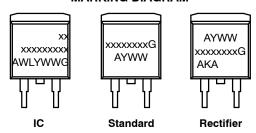
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GENERIC MARKING DIAGRAM*



xx = Specific Device Code A = Assembly Location

 WL
 = Wafer Lot

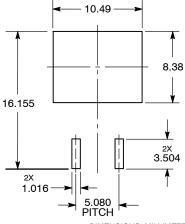
 Y
 = Year

 WW
 = Work Week

 G
 = Pb-Free Package

 AKA
 = Polarity Indicator

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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